1-1761199-3 ACTIVE

AMPLIMITE

TE Internal #: 1-1761199-3

SDL Connectors, Receptacle, Cable-to-Board, 8 Position, .05 in [1.27 mm] Centerline, Printed Circuit Board, Signal, Board Mount

View on TE.com >

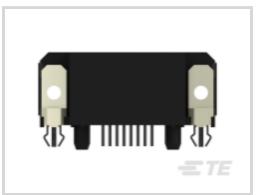


Connectors > Audio & Video Connectors > SDL Connectors











Connector & Housing Type: Receptacle

Connector System: Cable-to-Board

Number of Positions: 8

Centerline (Pitch): 1.27 mm [.05 in]

Connector & Contact Terminates To: Printed Circuit Board

Features

Product Type Features

Receptacle Configuration	Standard
Grounding Options	PCB and Panel Ground
Connector & Housing Type	Receptacle
Connector System	Cable-to-Board
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Number of Positions 8

Body Features

Shield Plating Material	Tin over Nickel
Shield Material	Brass

Contact Features

	50 μin
Contact Mating Area Plating Material	Gold
Contact Base Material	Phosphor Bronze



Contact Current Rating (Max)	1.5 A
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Mechanical Attachment

PCB Mount Retention	With
PCB Mount Retention Type	Boardlock
Polarization Code	A
Connector Mounting Type	Board Mount

Housing Features

Mating Entry Location	Side
Housing Material	Polyester GF
Housing Color	Black
Centerline (Pitch)	1.27 mm[.05 in]

Usage Conditions

Operating remperature range -20 - 60 C[-4 - 176 F]	Operating Temperature Range	-20 - 80 °C[-4 - 176 °F]
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Operation/Application

Circuit Application	Signal	
Industry Standards		
UL Flammability Rating	UL 94V-0	

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

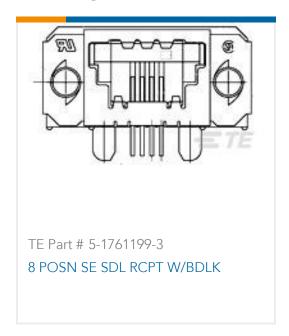
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent



chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Customers Also Bought

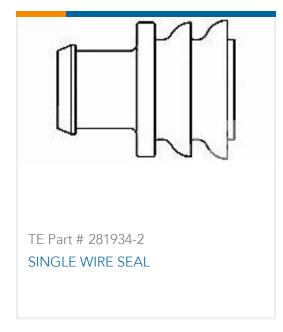














Documents

Product Drawings

8 POSN SE SDL RCPT W/BDLK

English

CAD Files

Customer View Model ENG_CVM_CVM_1-1761199-3_B.2d_dxf.zip

English



3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-1761199-3_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-1761199-3_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions**of use.

Product Specifications

Application Specification

English

Instruction Sheets

Instruction Sheet (U.S.)

English